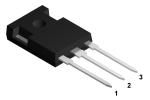
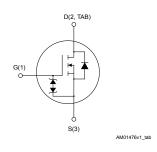




# Automotive-grade N-channel 600 V, 37 mΩ typ., 56 A, MDmesh DM6 Power MOSFET in a TO-247 long leads package



TO-247 long leads



#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STWA72N60DM6AG	600 V	42 mΩ	56 A

- AEC-Q101 qualified
- Fast-recovery body diode
- Lower R<sub>DS(on)</sub> per area vs previous generation
- · Low gate charge, input capacitance and resistance
- 100% avalanche tested
- · Extremely high dv/dt ruggedness
- · Zener-protected

#### **Applications**

· Switching applications

#### **Description**

This high-voltage N-channel Power MOSFET is part of the MDmesh DM6 fast-recovery diode series. Compared with the previous MDmesh fast generation, DM6 combines very low recovery charge  $(Q_{rr})$ , recovery time  $(t_{rr})$  and excellent improvement in  $R_{\text{DS}(\text{on})}$  per area with one of the most effective switching behaviors available in the market for the most demanding high-efficiency bridge topologies and ZVS phase-shift converters.



## Product status link STWA72N60DM6AG

Product summary			
Order code STWA72N60DM6AG			
Marking	72N60DM6		
Package	TO-247 long leads		
Packing	Tube		



## 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	±25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	56	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	35	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	230	Α
P <sub>TOT</sub>	Total power dissipation at T <sub>C</sub> = 25 °C	390	W
dv/dt (2)	Peak diode recovery voltage slope	100	V/ns
di/dt (2)	Peak diode recovery current slope	1000	A/µs
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	100	V/ns
T <sub>STG</sub>	Storage temperature range	-55 to 150	°C
TJ	Operating junction temperature range	-55 (0 150	°C

- 1. Pulse width is limited by safe operating area.
- 2.  $I_{SD} \le 56 \text{ A}, \ V_{DS}(peak) < V_{(BR)DSS}, \ V_{DD} = 400 \text{ V}$
- 3.  $V_{DS} \le 400 \text{ V}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance, junction-to-case	0.32	°C/W
R <sub>thJA</sub>	Thermal resistance, junction-to-ambient	50	°C/W

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )	7	Α
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	1850	mJ

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#### 2 Electrical characteristics

 $T_C$  = 25 °C unless otherwise specified

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	600			V
		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 600 V			5	
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_J = 125  {}^{\circ}\text{C}^{(1)}$			200	μA
I <sub>GSS</sub>	Gate-body leakage current	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±25 V			±5	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.25	4	4.75	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 28 A		37	42	mΩ

<sup>1.</sup> Defined by design, not subject to production test.

**Table 5. Dynamic characteristics** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	4444	-	
C <sub>oss</sub>	Output capacitance	$V_{DS} = 100 \text{ V, f} = 1 \text{ MHz, V}_{GS} = 0 \text{ V}$	-	304	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	8	-	
Coss eq. (1)	Equivalent output capacitance	V <sub>DS</sub> = 0 to 480 V, V <sub>GS</sub> = 0 V	-	729	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> = 0 A	-	1.6	-	Ω
$Q_g$	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 56 \text{ A},$	-	98	-	
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 0 to 10 V (see Figure 14. Test circuit for gate	-	30	-	nC
Q <sub>gd</sub>	Gate-drain charge	charge behavior)	-	35	-	

<sup>1.</sup>  $C_{\rm oss\ eq}$  is defined as a constant equivalent capacitance giving the same charging time as Coss when  $V_{\rm DS}$  increases from 0 to 80%  $V_{\rm DSS}$ 

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 28 A,	-	33	-	ns
t <sub>r</sub>	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$	-	30	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 13. Test circuit for resistive load switching times	-	97	-	ns
t <sub>f</sub>	Fall time	and Figure 18. Switching time waveform)	-	10	-	ns

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Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		56	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		230	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 56 A	-		1.6	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 56 A, di/dt = 100 A/μs,	-	153	-	ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>DD</sub> = 60 V	-	0.9	-	μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	10	-	A
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 56 A, di/dt = 100 A/μs,	-	285	-	ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>DD</sub> = 60 V, T <sub>J</sub> = 150 °C	-	3.4	-	μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	20	-	A

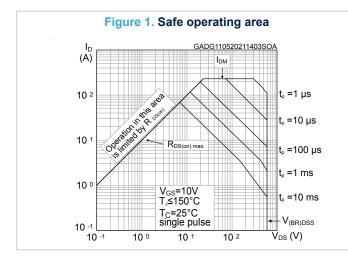
<sup>1.</sup> Pulse width is limited by safe operating area

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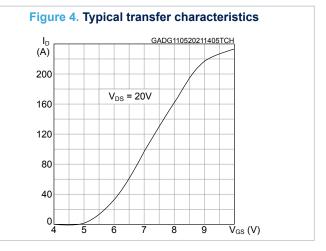
<sup>2.</sup> Pulsed: pulse duration = 300 µs, duty cycle 1.5%

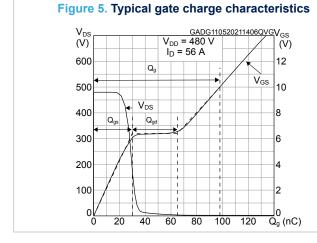


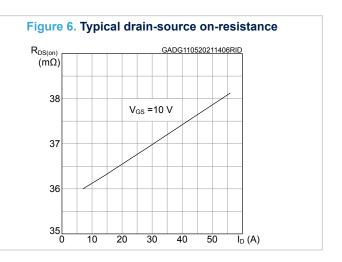
#### 2.1 Electrical characteristics (curves)



ZthJC (°C/W) duty=0.5 0.4 10 -3 10 -6 10 -5 10 -4 10 -3 10 -2 10 -1 tp (s)







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Figure 7. Typical capacitance characteristics

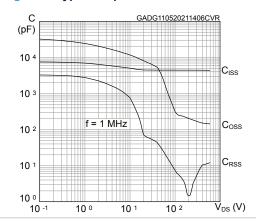


Figure 8. Typical output capacitance stored energy

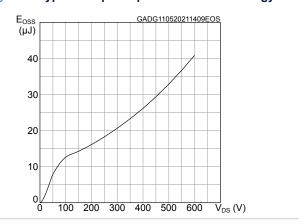


Figure 9. Normalized gate threshold vs temperature

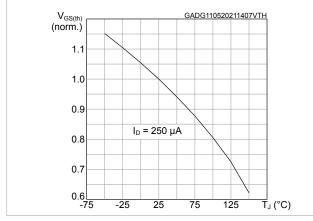


Figure 10. Normalized on-resistance vs temperature

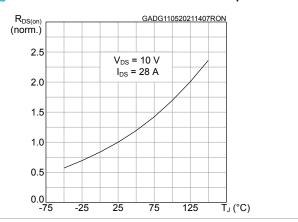


Figure 11. Normalized breakdown voltage vs temperature

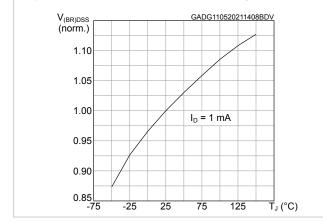
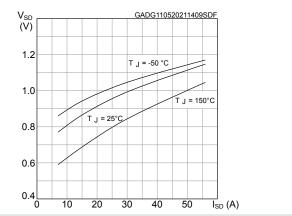


Figure 12. Typical reverse diode forward characteristics



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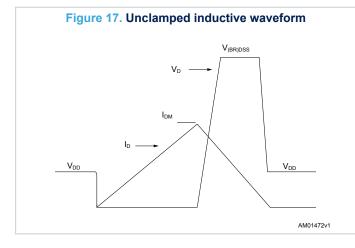
#### 3 Test circuits

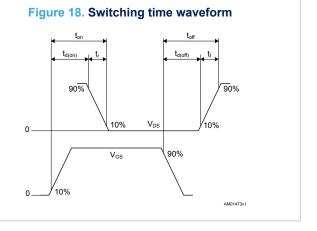
Figure 13. Test circuit for resistive load switching times

Figure 14. Test circuit for gate charge behavior

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Figure 16. Unclamped inductive load test circuit





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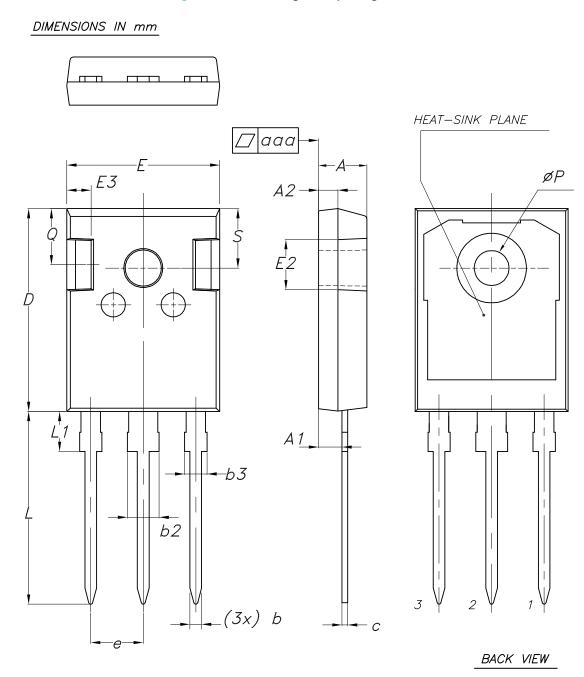


#### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

#### 4.1 TO-247 long leads package information

Figure 19. TO-247 long leads package outline



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Table 8. TO-247 long leads package mechanical data

Dim	mm				
Dim.	Min.	Тур.	Max.		
Α	4.90	5.00	5.10		
A1	2.31	2.41	2.51		
A2	1.90	2.00	2.10		
b	1.16		1.26		
b2			3.25		
b3			2.25		
С	0.59		0.66		
D	20.90	21.00	21.10		
E	15.70	15.80	15.90		
E2	4.90	5.00	5.10		
E3	2.40	2.50	2.60		
е	5.34	5.44	5.54		
L	19.80	19.92	20.10		
L1			4.30		
Р	3.50	3.60	3.70		
Q	5.60		6.00		
S	6.05	6.15	6.25		
aaa		0.04	0.10		

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## **Revision history**

Table 9. Document revision history

Date	Revision	Changes
17-Mar-2020	1	First release.
20-May-2021	2	Updated title and features in cover page.  Updated Section 1 Electrical ratings, Section 2 Electrical characteristics, Section 2.1 Electrical characteristics (curves) and Figure 14. Test circuit for gate charge behavior.  Minor text changes.

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